

#### Z-PACK | Z-PACK 2mm HM

TE Internal #: 100668-1

Hard Metric Backplane PCB Mount Header, ≤1 Gb/s, 22 Column, 7 Row, Mezzanine, 154 Position, 2 mm [.078 in] Centerline, Vertical,

Gray, Z-PACK 2mm HM

View on TE.com >

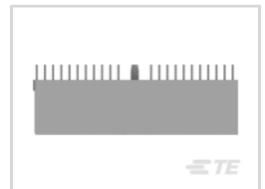


Connectors > PCB Connectors > Backplane Connectors > Hard Metric Backplane Connectors >

Hard Metric Male Connector: Traditional Backplane, Mezzanine, 2mm











PCB Connector Type: PCB Mount Header

Data Rate: ≤1 Gb/s

Number of Columns: 22

Number of Rows: 7

Number of Nows. 7

Backplane Architecture: Mezzanine

All Hard Metric Male Connector: Traditional Backplane, Mezzanine, 2mm (124)

### **Features**

### **Product Type Features**

| Connector & Contact Terminates To | Printed Circuit Board   |
|-----------------------------------|-------------------------|
| Ground Feature Type               | Ground Return Shielding |
| Backplane Interface Type          | 2mm HM                  |
| Connector System                  | Board-to-Board          |
| PCB Connector Type                | PCB Mount Header        |
| Sealable                          | No                      |

### **Configuration Features**

| Rows Loaded            | A, B, C, D, E, F, Z |
|------------------------|---------------------|
| Number of Columns      | 22                  |
| Number of Rows         | 7                   |
| Backplane Architecture | Mezzanine           |
| Number of Positions    | 154                 |



| PCB Mount Orientation                          | Vertical                   |
|--|----------------------------|
| Signal Characteristics                         |                            |
| Crosstalk Version                              | Standard                   |
| Data Rate                                      | ≤1 Gb/s                    |
| Body Features                                  |                            |
| Primary Product Color                          | Gray                       |
| Contact Features                               |                            |
| Contact Underplating Material                  | Nickel                     |
| Contact Mating Area Length                     | 13.45 mm                   |
| Contact Base Material                          | Phosphor Bronze            |
| CompactPCI Designation                         | None                       |
| PCB Contact Termination Area Plating Material  | Tin-Lead                   |
| Feedthrough Post Length                        | 3.7 mm                     |
| Contact Type                                   | Pin                        |
| Contact Mating Area Plating Material           | Gold (Au)                  |
| Contact Mating Area Plating Material Thickness | .76 μm[30 μin]             |
| Contact Current Rating (Max)                   | 1.5 A                      |
| Termination Features                           |                            |
| Termination Method to PCB                      | Through Hole - Press-Fit   |
| Mechanical Attachment                          |                            |
| Connector Mounting Type                        | Board Mount                |
| Mating Alignment Type                          | Multi-Purpose Center       |
| Front Mating Level                             | Level 1                    |
| Housing Features                               |                            |
| Housing Material                               | Polyester GF               |
| Centerline (Pitch)                             | 2 mm[.078 in]              |
| Dimensions                                     |                            |
| Backplane Module Length                        | 50 mm                      |
| Usage Conditions                               |                            |
| Operating Temperature Range                    | -55 – 125 °C[-67 – 257 °F] |
| Operation/Application                          |                            |



| Shielded               | Yes            |
|------------------------|----------------|
| Circuit Application    | Power & Signal |
| Industry Standards     |                |
| UL Flammability Rating | UL 94V-0       |
| Packaging Features     |                |
| Packaging Quantity     | 10             |
| Packaging Method       | Tube           |

### **Product Compliance**

For compliance documentation, visit the product page on TE.com>

| EU RoHS Directive 2011/65/EU                  | Not Compliant   |
|---|---|
| EU ELV Directive 2000/53/EC                   | Compliant with Exemptions   |
| China RoHS 2 Directive MIIT Order No 32, 2016 | Restricted Materials Above Threshold  |
| EU REACH Regulation (EC) No. 1907/2006        | Current ECHA Candidate List: JAN 2025 (247) Candidate List Declared Against: JAN 2025 (247) SVHC > Threshold: Pb (13% in 4690948374) Article Safe Usage Statements: Do not eat, drink or smoke when using this product. Wash thoroughly after handling. Recycle if possible and dispose of the article by following all applicable governmental regulations relevant to your geographic location. |
| Halogen Content                               | Not Low Halogen - contains Br or Cl > 900 ppm.  |
| Solder Process Capability                     | Not applicable for solder process capability  |

### Product Compliance Disclaimer

This information is provided based on reasonable inquiry of our suppliers and represents our current actual knowledge based on the information they provided. This information is subject to change. The part numbers that TE has identified as EU RoHS compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, mercury, PBB, PBDE, DBP, BBP, DEHP, DIBP, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2011/65/EU (RoHS2). Finished electrical and electronic equipment products will be CE marked as required by Directive 2011/65/EU. Components may not be CE marked. Additionally, the part numbers that TE has identified as EU ELV compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, and mercury, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2000/53/EC (ELV). Regarding the REACH Regulation, the information TE provides on SVHC in articles for this part number is based on the latest European Chemicals Agency (ECHA) 'Guidance on requirements for substances in articles' posted at this URL: https://echa.europa.eu/guidance-documents/guidance-on-reach

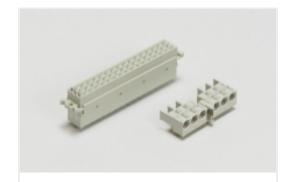
## **Compatible Parts**



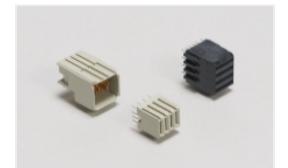




### Also in the Series | Z-PACK 2mm HM



Backplane Connector Housings(4)



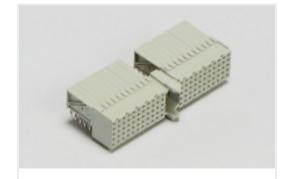
Backplane Power Connectors(1)



Connector Caps & Covers(62)



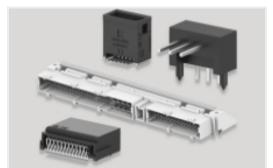
Connector Hardware(91)



Hard Metric Backplane Connectors (266)



Insertion & Extraction Tools(2)



PCB Headers & Receptacles(46)



Rectangular Power Connectors(46)

# Customers Also Bought



TE Part #5223957-3 UPM GUIDE MODULE



TE Part #5188578-1 Z-PACK/A M HDR.154P



TE Part #1469028-1 HM-ZD 2PR RECP 40P



TE Part #646478-5 2MM H.M.,"A" SHROUD, 4.5MM



TE Part #120954-1
TE UPM R/A Header 4P HC Power,
LLLL



TE Part #2007637-5 SFP+ assy 2x2 Spring Fingers 4 LP Sn

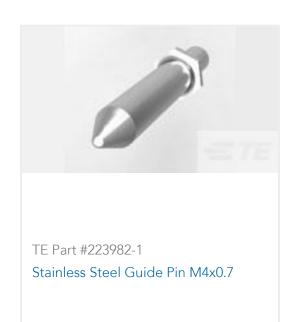


TE Part #1469025-1 HM-ZD 2PR HDR 40P 2.5MM



TE Part #120953-1
TE UPM Ver Receptacle 4P HC Power







#### **Documents**

### **Product Drawings**

Z-PACK M.ASSY.154P.

English

#### **CAD Files**

**Customer View Model** 

ENG\_CVM\_CVM\_100668-1\_H.2d\_dxf.zip

English

3D PDF

3D

**Customer View Model** 

ENG\_CVM\_CVM\_100668-1\_H.3d\_igs.zip

English

**Customer View Model** 

ENG\_CVM\_CVM\_100668-1\_H.3d\_stp.zip

English

By downloading the CAD file I accept and agree to the **Terms and Conditions** of use.

### **Product Specifications**

**Application Specification** 

English